

4

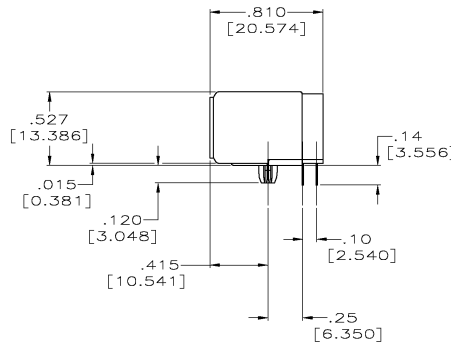
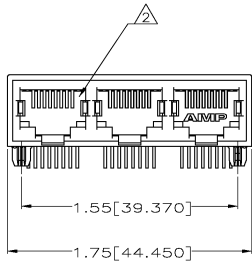
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LOC	QTY	REV	DESCRIPTION	DATE	BY	APP
AA	22	A	EODS11-0201-04	10MAY2005	LAM	SF

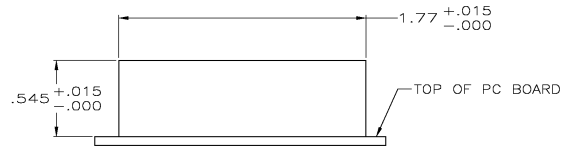
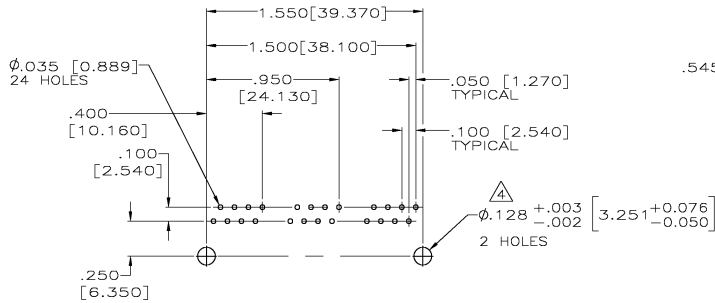


- MATERIAL: HOUSING - HTN NYLON, BLACK, IR REFLOW PROCESSING COMPATIBLE, UL 94V-0. TERMINALS - .013[0.33] THICK PHOS BRONZE PLATED WITH .000050[1.27µm] THICK HARD GOLD IN LOCALIZED AREA AND .000150[3.81µm] THICK MATTE TIN IN SOLDER AREA OVER .000050[1.27 µm] THICK NICKEL UNDERPLATE.

△ JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART F.

3. ALL DIMENSIONS SHOWN IN BRACKETS [] ARE IN MILLIMETERS.

△ USE #30 DRILL BIT OR 3.25 MM DRILL BIT WHEN PRODUCING THESE PRINTED CIRCUIT BOARD HOLES.



SUGGESTED PANEL CUTOUT

SUGGESTED PC BOARD LAYOUT COMPONENT SIDE SEE APPLICATION SPECIFICATION

5557561-1 PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DN: V. SLACK/L.A. MAYER	10MAY2005	 Tyco Electronics Corporation Harrisburg, Pa 17105-3608	PART NUMBER	
DIMENSIONS: INCHES		CHK: J. WESTMAN	10MAY2005		5557561-1	
TOLERANCE LIMITS: DIMENSIONS UNLESS OTHERWISE SPECIFIED		APPRO: S. ELKESINGER	10MAY2005	MODULAR JACK ASSEMBLY, THREE PORT, 8 POSITION, RIGHT ANGLE		
MATERIAL: SEE NOTE 1		PRODUCT SPEC: 108-1163	APPLICATION SPEC: 114-2048	SIZE: A2	DATE CODE: 00779	DRAWING NO: C=5557561
FINISH: SEE NOTE 1		HEIGHT: -	CUSTOMER DRAWING	SCALE: 2:1	SHEET: 1 OF 1	REV: A

5557561

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